



1762

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Appln. Ser. No.:	Filed:	Inventor(s):	Atty Dkt:
09/074,012	5 May 1998	S. YOSHIDA <i>et al.</i>	114GI-121 (0694-121)
Title: High Thermal Conductivity Composite Magnetic Body			
Examiner: B.D. Pianalto		Art Unit: 1762	

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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Dear Sir:

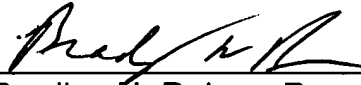
Pursuant to 37 CFR § 1.56, submitted herewith under § 1.97(b)(4) is information submitted in connection with the Information Disclosure Statement submitted with the filing of a Request for Continued Examination on 6 May 2004. An English-language translation of the claims of the previously submitted JP 59-132196 is attached. A new reference, JP 8-143988, including an English language translation of the abstract and detailed description is attached as obtained from the Japanese Patent Office IPDL, and is submitted and listed on the duplicate Substitute 1449/PTO forms attached.

**CERTIFICATE OF MAILING OR
TRANSMISSION – 37 CFR 1.8**

Respectfully submitted,

I hereby certify that I have a reasonable basis that this paper, along with any referred to above, (i) are being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450, or (ii) are being transmitted to the U.S. Patent & Trademark Office in accordance with 37 CFR § 1.6(d).

DATE: 10 May 2004
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